11-13-2001 EET U.S. DEPARTMENT OF COMMERC FORM PTO-1595 (Rev. 6-93) Patent and Trademark Offic OMB No. 0651-0011(e 101895789 To the A ant Commissioner for ____ documents or copy thereof. 1. Name of conveying party(ies): 2. Name and address of receiving party(ies): Hidemitsu NAYA Rikio TOMIYOSHI Name: HITACHI, LTD. Shigeo MORIYAMA Mutsumi KIKUCHI Kotaro SHIMAMURA Internal Address: Street Address: 6, Kanda Surugadai 4-chome Additional name(s) of conveying party(ies) attached? □Yes ⊠No Chiyoda-ku, Tokyo 101, JAPAN 3. Nature of conveyance: Additional name(s) & address(es) attached? □Yes ⊠No □ Merger □ Security Agreement □ Change of Name □ Other_____ Execution Date: 3, 3, 9, 3, 4 Aug. 2001 4. Application number(s) or patent number(s); If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No.(s) B. Patent No.(s) 09/942,425 Additional numbers attached: ☐ Yes ☑ No 5. Name and address of party to whom correspondence 6. Total number of applications concerning document should be mailed: and patents involved: 7. Total fee (37 CFR 3.41).....\$40.00 John C. Altmiller Kenyon & Kenyon □ Enclosed 1500 K Street, N.W., Suite 700 Washington, DC 20005-1257 8. Deposit account number: 11-0600 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. John C. Altmiller 6 November 2001 Name of Person Total humber of pages including cover sheet, attachments, and document: 2 OMB No. 0651-0011 (exp. 4/94) 11/07/2001 JBALINAN 00000045 110600 09942425 02 FC:581 40.00 CH

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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fullyand entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

RECORDED: 11/06/2001

INVENTOR(S)

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